

IREDS and PHOTOTRANSISTORS



IRED package options



SLED-56E__

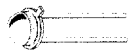


SLED-56HF__



SLED-56HL__

PTX package options



SLT-50E__



SLT-50HF__



SLT-50HL__

Silonex packages IREDS and phototransistors in TO-46 flat and lensed window hermetic cans as well as open construction TO-46 can base where the chip is protected by epoxy encapsulation.

LED chip technologies include GaAlAs (880nm), GaAs (940nm) and Gap (700nm). In addition to our current phototransistors, Silonex has two larger area phototransistors in development.

- Quality hermetic package
- "Can isolated" available
- Parameter selection available
- Building Block and Custom solutions available

PART No.	Output Power	Peak Wavelength	Forward Voltage	Reverse Breakdown	Reverse Current
	$I_F=50mA$ Min. (mW)	Typ. (nm)	$I_F=60mA$ Max. (V)	$I_R=10\mu A$ Min. (V)	$V_R=3V$ Max. (μA)
SLED-56HL1	1.0	940	1.8	3	10
SLED-56HF1	1.0	940	1.8	3	10
SLED-56E1	1.0	940	1.8	3	10
SLED-56HL2	3.0	880	1.6	5	10
SLED-56HF2	3.0	880	1.6	5	10
SLED-56E2	3.0	880	1.6	5	10
SLED-56HL3	0.2 *	700	2.4 **	3	10
SLED-56HF3	0.2 *	700	2.4 **	3	10
SLED-56E3	0.2 *	700	2.4 **	3	10

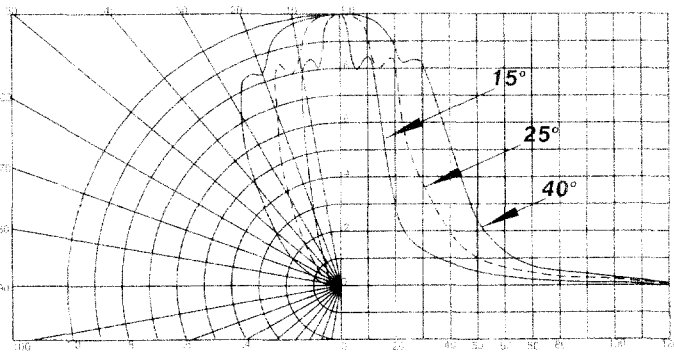
* $I_F=5mA$ ** $I_F=30mA$

PART No.	Light Current	Dark Current	Collector Breakdown	Emitter Breakdown	Saturation Voltage	Rise/Fall Time
	$V_{CE}=5V$ ⁽¹⁾ $E_e=5mW/cm^2$ Min. (mA)	$V_{CE}=10V$ $E_e=0$ Max. (nA)	$I_C=100\mu A$ $E_e=0$ Min. (V)	$I_C=100\mu A$ $E_e=0$ Min. (V)	$I_C=100mA$ $I_B=0.5mA$ Max. (V)	$I_C=0.8mA$ ⁽²⁾ $R_L=100\Omega$ Typ. (μsec)
SLT-50HF3	1.0	50	40	7.5	0.4	3
SLT-50HF4	2.5	50	40	7.5	0.4	3
SLT-50HL3	2.4	50	40	7.5	0.4	3
SLT-50HL4	4.0	50	40	7.5	0.4	3

(1) Light source is a frosted Tungsten incandescent Lamp @ 2854°K.

(2) Light source is a GaAs IRED with a $T_r < 300ns$.

TO-46 IRED Beam Emission Patterns



Sensor Directional Sensitivity Characteristics

